

Electronic Acknowledgement Receipt

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Application Number:	10578028
International Application Number:	
Confirmation Number:	9578
Title of Invention:	Thin film diode panel and manufacturing method of the same
First Named Inventor/Applicant Name:	Kyoung-Ju Shin
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Application Type:	U.S. National Stage under 35 USC 371

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	PANK01883US_IDS_Form__SB_08a_EF.pdf	787187 d6691893f7ac215d2f7b312db2c7653111f505b	no	4

Warnings:

Information:

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2	Foreign Reference	PANK01883US_IDS_FR_113323_5_EF.pdf	4515142 H7491db116d6ca9a4129ac11a61a07f7cd14	no	13
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Warnings:

Information:

3	Foreign Reference	PANK01883US_IDS_FR_142692_9_EF.pdf	4155565 d1426a2a1e8c012a3803c309d27773c786c4528	no	12
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National Stage of an International Application under 35 U.S.C. 371

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